

In the United States Patent and Trademark Office

Appn. Number: \_\_\_\_\_  
Appn. Filed: May 23, 2001  
Applicant: Howard Hong-Dough Lee  
Appn. Title: ENERGY-CONSERVING APPARATUS AND OPERATING SYSTEM HAVING MULTIPLE OPERATING FUNCTIONS  
Examiner/GAU: \_\_\_\_\_

1c973 U.S. PTO  
09/863177  
05/23/01

**Petition to Make Special**

United States Department of Commerce  
Patent and Trademark Office  
Commissioner of Patents and Trademarks  
Washington, District of Columbia 20231

May 23, 2001

Dear Sir:

Applicant hereby respectfully petitions that the above application be made special under MPEP § 708.02 for the following reason; attached is declaration in support thereof:

- I. ☐ Manufacturer Available\*;
- II. ☐ Infringement Exists\*;
- III. ☐ Applicant's Health Is Poor;
- IV. ☐ Applicant's Age is 65 Or Greater;
- V. ☐ Environmental Quality will be Enhanced;
- VI. ☒ Energy Savings Will Result;
- VII. ☐ Recombinant DAN is involved\*;
- VIII. ☐ Special Procedure: Search Was Made\*.

Very respectfully,



Howard Hong-Dough Lee  
Applicant

4350 Derry Road  
Bloomfield, MI 48302  
Mailed: May 23, 2001

In The United States Patent And Trademark Office

Mailed May 23, 2001

Box Patent Application  
Assistant Commissioner for Patents  
Washington, District of Columbia 20231

Dear Sir:

Please file the following enclosed petition papers:

Applicant: Howard Hong-Dough Lee

Title: ENERGY-CONSERVING APPARATUS AND OPERATING SYSTEM HAVING MULTIPLE OPERATING  
FUNCTIONS

Sr. No.: \_\_\_\_\_

(x) Petition to Make Special (3 pages of Declaration)

Very respectfully,



\_\_\_\_\_  
Sole Inventor: Howard Hong-Dough Lee

Correspondence Address (Please Send to:)  
4350 Derry Road  
Bloomfield, MI 48302

EXPRESS MAIL LABEL # EJ347957013US; DATE OF DEPOSIT: May 23, 2001

I hereby certify that this paper and fee is being deposited with the United States Postal Service using "Express Mail Post Office To Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to "Commissioner of Patents and Trademarks, Washington, DC 20231."

Signed:

\_\_\_\_\_  
Sole Inventor: Howard Hong-Dough Lee

